



### **IPR Notice**

All rights, titles and interests contained in this information, texts, images, figures, tables or other files herein, including, but not limited to, its ownership and the intellectual property rights, are reserved to eMemory. This information may contain privileged and confidential information. Some contents in this information can be found in Logic Non-Volatile Memory (The NVM solutions from eMemory), published in 2014. Any and all information provided herein shall not be disclosed, copied, distributed, reproduced or used in whole or in part without prior written permission of eMemory Technology Inc.

eMemory, NeoBit, NeoFuse, NeoEE, NeoMTP, NeoROM, EcoBit and NeoPUF are all trademarks and/or service marks of eMemory in Taiwan and/or in other countries.



# **Cautionary Statement**

This presentation contains forward-looking statements, which are subject to risk factors associated with semiconductor and intellectual property business. It is believed that the expectations reflected in these statements are reasonable. But they may be affected by a variety of variables, many of which are beyond our control. These variables could cause actual results or trends to differ materially which include, but are not limited to: wafer price fluctuation, actual demand, rapid technology change, delays or failures of customers' tape-outs into wafer production, our ability to negotiate, monitor and enforce agreements for the determination and payment of royalties, any bug or fault in our technology which leads to significant damage to our technology and reputation, actual or potential litigation, semiconductor industry cycle and general economic conditions. Except as required by law, eMemory undertakes no obligation to update or revise any forward-looking statements, whether as a result of new information, future events, or otherwise.



### **Contents**

- 1 Review of Operations
- 2 Future Outlook
- 3 How PUF Works for AI Security
- 4 Q&A
- 5 Appendix



### **Q3 2020 Financial Results**

The EPS of Q3 2020 was 2.26 NTD, ROE was 38.8%

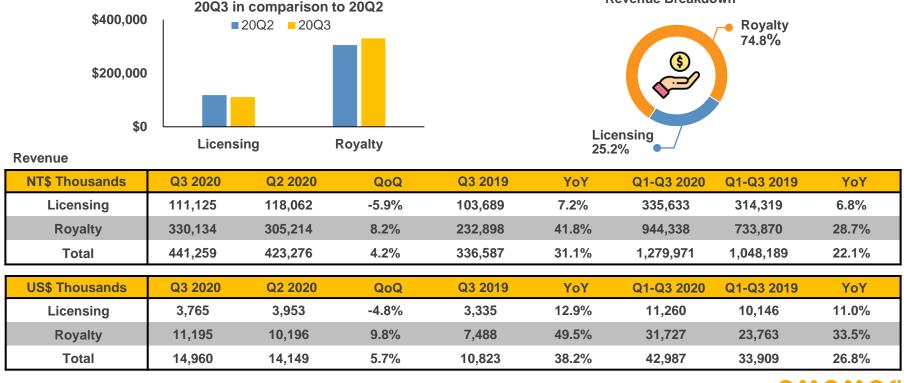
#### (thousands of NT dollars)

•	,							
	Q3 2020	Q2 2020	Change (QoQ)	Q3 2019	Change (YoY)	Q1-Q3 2020	Q1-Q3 2019	Change (YoY)
Revenue	441,259	423,276	4.2%	336,587	31.1%	1,279,971	1,048,189	22.1%
Gross Margin	100%	100%	-	100%	-	100%	100%	-
Operating Expenses	243,913	227,364	7.3%	197,399	23.6%	692,740	586,376	18.1%
Operating Income	197,346	195,912	0.7%	139,188	41.8%	587,231	461,813	27.2%
Operating Margin	44.7%	46.3%	-1.6 ppts	41.4%	3.3 ppts	45.9%	44.1%	1.8 ppts
Net Income	168,581	169,317	-0.4%	120,170	40.3%	514,656	412,419	24.8%
Net Margin	38.2%	40.0%	-1.8 ppts	35.7%	2.5 ppts	40.2%	39.3%	0.9 ppt
EPS (Unit: NTD)	2.26	2.28	-0.9%	1.62	39.5%	6.92	5.56	24.5%
ROE	38.8%	41.9%	-3.1 ppts	29.1%	9.7 ppts	39.5%	33.3%	6.2 ppts

Note: Revenue of Q3 2020 in terms of US\$ is US\$14.96 mil, up 5.7% QoQ, and up 38.2% YoY.

### **Revenue in Different Stream**

Q3 revenue up 38.2% YoY in US dollar terms



Revenue Breakdown

## Revenue by Technology

The royalty of NeoFuse has a growth of 128.2% YoY in Q3

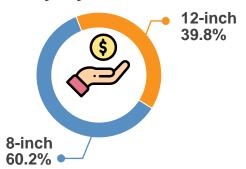
					Q3 2020				
	Т	otal Revenu	ie	Lice	nsing Reve	nue	Ro	yalty Reven	ue
Technology	% of Q3 Revenue	Change (QoQ)	Change (YoY)	% of Q3 Licensing	Change (QoQ)	Change (YoY)	% of Q3 Royalty	Change (QoQ)	Change (YoY)
NeoBit	53.7%	7.3%	10.4%	22.4%	22.5%	-31.4%	64.2%	5.8%	18.9%
NeoFuse	39.8%	-2.4%	84.9%	61.7%	-18.2%	42.7%	32.4%	11.4%	128.2%
PUF-Based	1.4%	120.6%	100.0%	5.6%	120.6%	100.0%	0.0%	0.0%	0.0%
MTP	5.1%	13.6%	-16.1%	10.3%	3.0%	-40.9%	3.4%	26.9%	45.5%

	Q1-Q3 2020						
	Total Revenue		Licensing	Revenue	Royalty Revenue		
Technology	% of Q1-Q3 Revenue	Change (YoY)	% of Q1-Q3 Licensing	Change (YoY)	% of Q1-Q3 Royalty	Change (YoY)	
NeoBit	53.2%	3.6%	20.7%	-17.5%	64.7%	6.7%	
NeoFuse	41.3%	71.8%	67.6%	27.1%	31.9%	133.7%	
PUF-Based	0.7%	1,429.3%	2.9%	1,429.3%	0.0%	0.0%	
MTP	4.8%	-25.9%	8.8%	-41.9%	3.4%	-0.3%	

### Royalty Revenue by Wafer Size

12-inch wafer increased 70.5% YoY

#### **Q3 Royalty Breakdown**



- √ 12-inch wafers contributed 39.8% of royalty, increased 19.8% sequentially and 70.5% YoY.
- √ 8-inch wafers contributed 60.2% of royalty, increased 1.7% sequentially and 27.6% YoY.

#### Royalty

		Q3 2020	Q1-Q3 2020		
Wafer Size	% of Q3	Change (QoQ)	Change (YoY)	% of Q1-Q3	Change (YoY)
8-Inch	60.2%	1.7%	27.6%	62.7%	16.9%
12-Inch	39.8%	19.8%	70.5%	37.3%	55.0%



### eMemory Embedded Everywhere

eMemory's IP seeks to penetrate across all the applications



#### **✓ Product Applications:**

eMemory's IP are already applied into different applications, which includes PMIC, LCD driver, Sensors, RFID, OLED Driver, Connectivity IC, DTV, STB, SSD Controller, Bluetooth, TDDI, MCU, Fingerprint Sensor, Smart Meters, Surveillance, ISP, CIS, DRAM, embedded Flash and FPGA.

#### **✓ Future Target:**

AP, GPU, CPU, Flash, IoT, AI, autonomous driving



#### ✓ The Future in Security Chip IP:

The rapid growth in AloT and 5G drive the demand for hardware security. OTP and PUF are indispensable for root of trust in hardware security.

#### **✓ PUF-based Security Solutions:**

To satisfy the market needs, eMemory developed a new series of PUF-based security solution, including PUFrt, PUFiot, PUFse and PUFflash.

### **Our Perspectives**

eMemory continue to create value for the industry and our shareholders

Licensing & Royalty



#### ✓ Licensing:

 NeoFuse and NeoPUF will continue to grow due to increasing demand for design license activity and technology platforms that are continuously built among foundry partners.

#### **✓** Royalty:

- 8" royalty will grow due to PMIC content increase in 5G smartphone and demand pick-up for automotive and IoT applications.
- 12" royalty will have a strong growth as customers are ramping up productions for ISP, OLED, Networkingrelated such as WiFi 6, Multimedia-related, DRAM, SSD controller and others.



New Application & Technology Development

#### **✓ For New Business Development:**

- NeoFuse in advanced process is adopted for secure key storage. We expect this will be a trend for security requirement.
- Business activities of PUF-based security solutions are in progress in applications of IoT, IIoT, AI, Blockchain, DPU, UFS, and automotives.
- Partnership with ARM and RISC-V will extend our PUF-based security platform.

#### ✓ For New IP Technology Development:

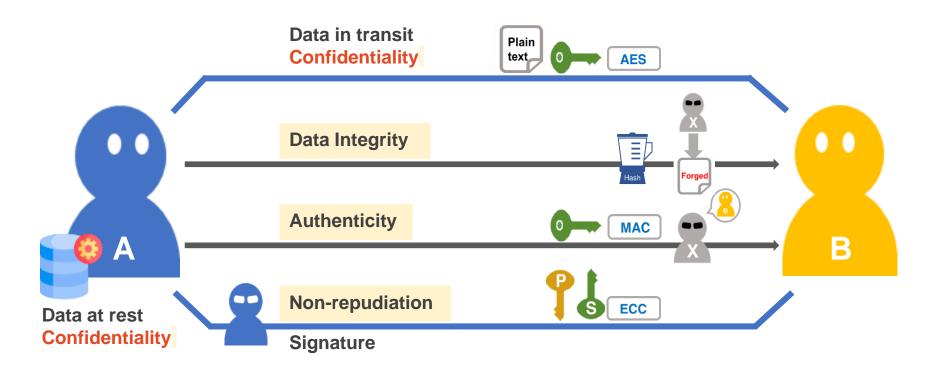
- Developing 6nm and 5nm plus (N5P) technology with leading foundry partners; demonstrated 6nm silicon results successfully.
- Announced crypto processor, PUFiot
- Develop PUF-based solution to be implemented in HSM.

ememory



### **Typical AI Security Concerns We Face**

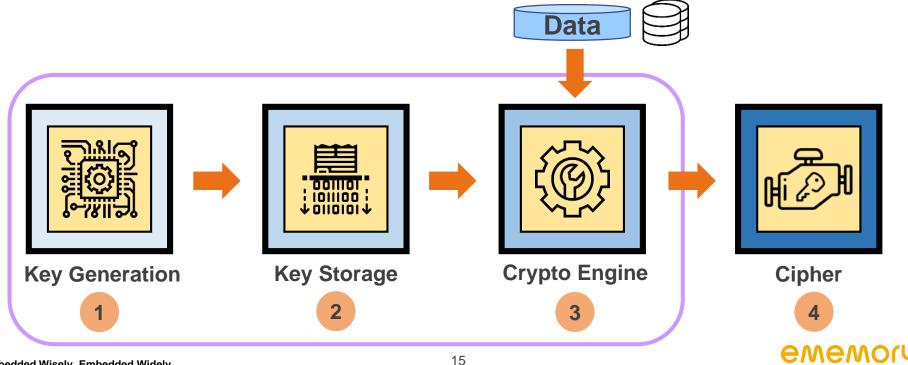
We utilize cryptographic operations and keys to ensure security



### The Foundation of Al Security: RoT

We refer to the anchor of secure device as Root-of-Trust (RoT)

Protecting keys right from generation is therefore pivotal



# Towards a RoT for AI Security

Generating key, storing key and using key in cryptographic operation

It all comes down to 3 essential problems to solve.



How can we generate secret key?



→ Chip Fingerprint



How can we store keys securely?



Static & Dynamic Entropy from Root-of-Trust



How can we secure key usage in operations?

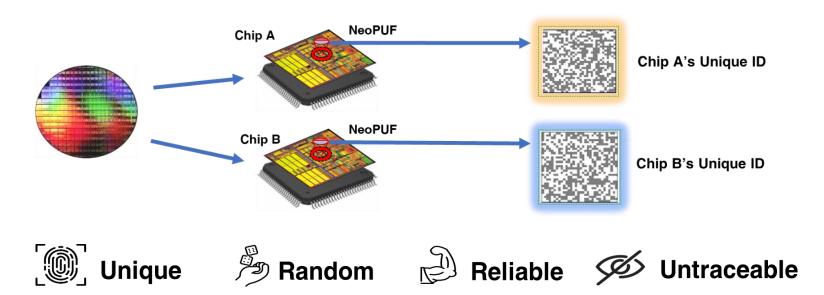


**Equip Root-of-Trust with** complete set of algorithms

### **NeoPUF: The Inborn Chip Fingerprint**

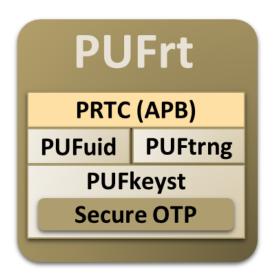
A truly random sequences for applications with high security requirements can be generated

 NeoPUF utilizes Quantum Tunneling mechanism to generate a one-andonly "biometric identifier" of each and every chip



#### **PUFrt: A PUF-based Hardware RoT**

PUFrt integrates altogether key generation, key storage, and entropies to protect operations



A Highly Integrated PUF-based HRoT with complete Anti-tampering Design



On-chip <u>UIDs</u> for Authentication



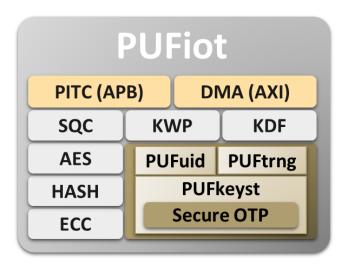
PUF-based TRNG for crypto usages



### **PUFiot: A PUF-based Security Crypto Processor**

PUFiot incorporates crypto-algorithms, enabling all security functions

# A HW Crypto processor with entropy protection on data, keys and crypto operations





- Key Generation
- Key Wrapping



- Integrity Check
- Encryption



 Symm. & Asymm. Authentication



- Secure Boot
- TLS
- · Key mgmt.



# **PUF-based Solutions Secure All Al Operations**

PUFrt and PUFiot enhance security functions during AI operations

Security Al Operation	Threat Model	Countermeasure	Security Function	Security Solution
Device Boot & Authentication	<ul><li>Malicious FW loaded</li><li>Unauthorized device</li></ul>	<ul><li>Secure Booting</li><li>Authentication and Provisioning</li></ul>	<ul><li>Secure key storage</li><li>Unique Identifier (UID)</li></ul>	PUFrt PUF-based Root of Trust
Model Training & Deployment	<ul><li>Training Data stolen</li><li>Model stolen from edge</li><li>Data/Model Modified</li></ul>	<ul><li>Protect data-in-transit</li><li>Protect deployed model</li><li>Integrity Check</li></ul>	Data/Model Encryption     Hashing and Signature	PUFiot  PUF-based  Crypto Processor
Input & Inference	<ul><li>Unauthorized user</li><li>User data privacy leak</li><li>Input/Result tampered</li></ul>	<ul> <li>Authentication and Provisioning</li> <li>Protect data-at-rest</li> <li>Ensure integrity/source</li> </ul>	<ul><li> Unique Identifier (UID)</li><li> Data Encryption</li><li> Hashing and Signature</li></ul>	PUFiot PUF-based Crypto Processor

### Summary: PUF-based Solutions for Al Security

The underlying benefit of using a PUF in cryptography is its "uniqueness" and "unpredictability"



# **NeoPUF-based Hardware Root of Trust**, containing NeoPUF and OTP, provides



- Unique Identity
- Secure Key Storage
- True Random Number Generator
- Anti-Tampering Solutions



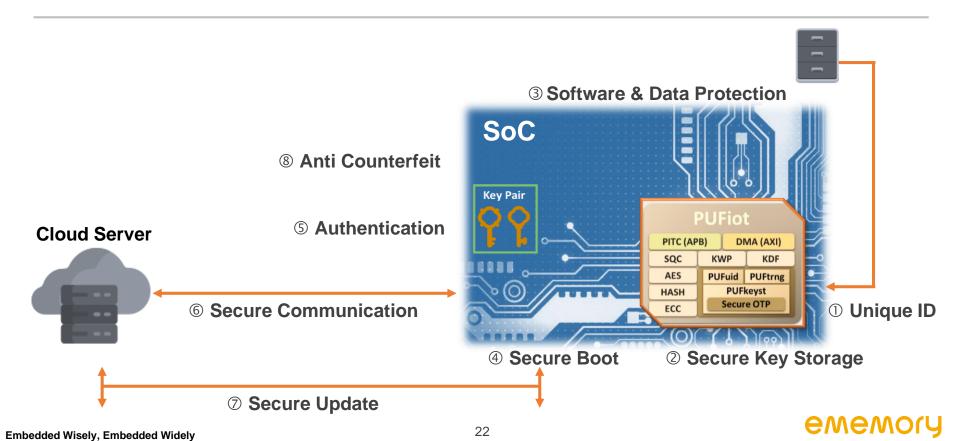
#### **Plus**

- High Manufacturability
- Ultra Low Cost



A High Value Proposition for Secure Al Applications

# PUF-based Solutions Safeguard Products Throughout Entire Lifecycle



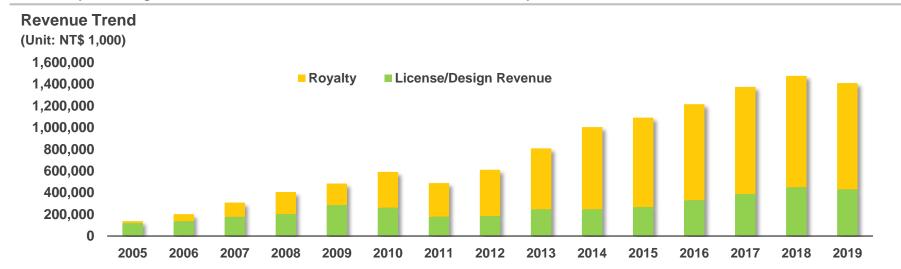


Q&A



# **Company Overview**

eMemory is the global leader of embedded non-volatile memory IP



#### Founded In 2000

Based in Hsinchu, Taiwan. IPO in 2011. Over 31M wafers shipped.

# Patents Issued

263 pending patents. 286 employees with 67% R&D personnel. 25

#### st IP Partner With TSMC

TSMC Best IP Partner Award since 2010.

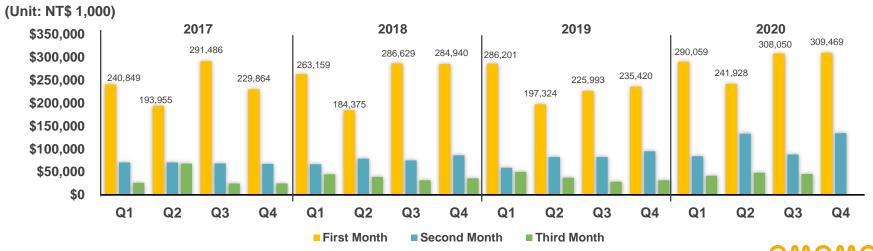
ememory

### **Quarterly Revenue Pattern**

#### eMemory's quarterly revenue pattern

- √ 1<sup>st</sup> month: Receive License Fees of the month and Royalty from most foundries on previous quarter's wafer shipments.
- ✓ 2<sup>nd</sup> month: Receive License Fees of the month and Royalty from other foundries.
- ✓ 3<sup>rd</sup> month: License Fees Only.

Note: One foundry pays royalty semiannually, reported in Jan and July revenue.



### **Worldwide Customers**

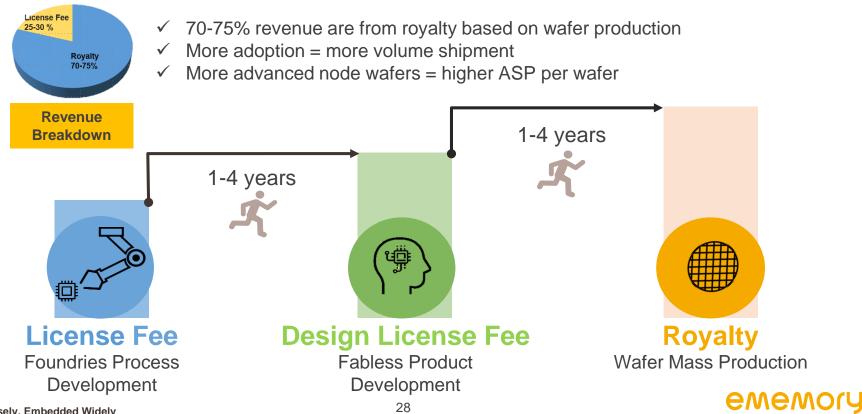
Our IP solutions are adopted by leading foundries, IDMs and fabless worldwide

Country	Foundry	IDM	Fabless
Taiwan	4	1	302
China	8	0	812
Korea	4	0	87
Japan	4	7	64
North America	1	1	306
Europe	2	1	177
Others	1	0	76



#### **Business Model**

Recurring royalty is the backbone of our business



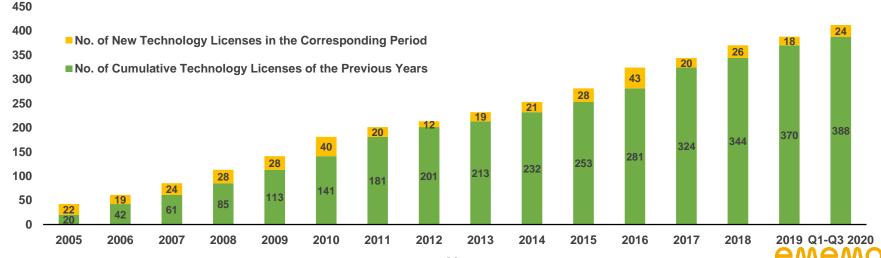
## **Technology Licenses**

#### Cumulative technology licenses

#### **Number of Licenses**

Year	2016	2017	2018	2019	Q1-Q3 2020
License	43	20	26	18	24

Note: Terms (including number of process platforms and licensing fees) for each technology license are set contractually. Payments are made according to set milestones, and there are no particular seasonal factors involved.



### **New Technology Under Development**

Products in different process nodes

- ✓ New technologies are being developed for 98 platforms by Q3 2020.
- ✓ 7 licensing contracts were signed, 6 for NeoFuse and 1 for NeoMTP.

Technology	5/6nm	7/10nm	12/16nm	<b>22/28</b> nm	<b>40</b> nm	55/65nm	80/90nm	0.11~ 0.13um	0.15~ 0.18um	>0.25um
NeoBit	-	-	-	-	-	1	2	10	10	1
NeoFuse	2	1	3	9	3	11	8	1	1	-
PUF-Based	2	-	2	2	2	1	-	-	-	-
MTP	-	-	-		-	2	6	9	9	-

Note: As of Sep 30th, 2020

# **Technology Development**

#### Developments by process nodes

12" Fabs	Production	Development	IP Type	Process Type
5/6nm	0	4	OTP, PUF	FF
7/10nm	2	1	OTP, PUF	FF, FF+
12/16nm	3	5	OTP, PUF	FF, FF+
22/28nm	31	11	OTP, PUF, MTP	LP/ULP/ULL, HPC/HPC+, HV-OLED, DRAM, SOI
40nm	15	5	OTP, PUF, MTP	LP/ULP, E-Flash, HV-DDI/OLED
55/65nm	25	15	OTP, PUF, MTP	LP/ULP, E-Flash, HV-DDI/OLED, DRAM, CIS, BCD, PM
80/90nm	16	15	OTP, MTP	HV-DDI/OLED, LP, Generic, BCD, CIS
0.11/0.13um	17	3	OTP, MTP	HV-DDI, BCD, Generic
0.18um	1	3	OTP	BCD, Generic
Total	110	62		

8" Fabs	Development	IP Type	Process Type
90nm	1	ОТР	HV-DDI, LL, BCD
0.11/0.13um	17	OTP, MTP	HV/HV-MR, BCD, LP/LL, CIS, Green, Flash, SOI, Generic
0.152/0.16/0.18um	17	OTP, MTP	HV/HV-MR, BCD, LP/LL, CIS, Green, Generic
0.25um	1	ОТР	BCD
0.35um	0	ОТР	UHV
Total	36		

Note: As of Sep 30th, 2020

